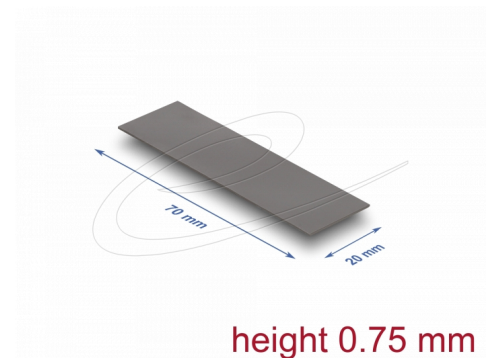


# Delock Thermal Conductive Pad 70 x 20 x 0.75 mm for M.2 modules 3.0 W/mK

## Description

This thermal conductive pad by Delock is suitable for heat dissipation, for example, on an M.2 module. The goal of the pad is to **improve performance and increase the service life** of the components.



**Item no. 18473**

EAN: 4043619184736

Country of origin: Taiwan,  
Republic of China

Package: Zip poly bag

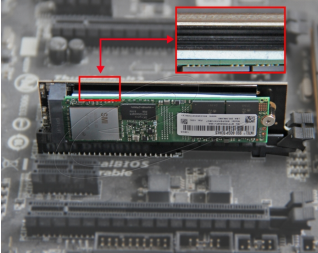
## Technical details

- Thermal pad for heat dissipation
- Thermal conductivity: 3.0 W/mK
- Operating temperature: -60 °C ~ 180 °C
- Colour: grey
- Dimensions (LxWxH): ca. 70 x 20 x 0.75 mm

## Package content

- 1 x thermal conductive pad

## Images



## Physical characteristics

|                       |          |
|-----------------------|----------|
| Thermal conductivity: | 3.0 W/mK |
| Length:               | 70 mm    |
| Width:                | 20 mm    |
| Height:               | 0.75 mm  |

## Manufacturer information

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|             |                   |
|-------------|-------------------|
| Street      | Beeskowdamm 13/15 |
| Postal code | 14167             |
| City        | Berlin            |
| Country     | Deutschland       |
| E-Mail      | info@delock.de    |
| Website     | www.delock.de     |